



1732

PATENT  
Customer No. 22,852  
Attorney Docket No. 04329.2583

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: )  
)  
Mika KIRITANI ) Group Art Unit: 1732  
)  
Application No.: 09/887,104 ) Examiner: Ortiz, A.  
)  
Filed: June 25, 2001 )  
)  
For: SEMICONDUCTOR RESIN MOLD )  
AND SEMICONDUCTOR RESIN )  
MOLDING METHOD USING THE )  
MOLD )

RECEIVED  
OCT 24 2003  
TC 1700

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**RESPONSE TO RESTRICTION REQUIREMENT**

In the Office Action dated September 23, 2003, the period for response to which extends through October 23, 2003, the Examiner required restriction under 35 U.S.C.

§121 between the following groups:

Group I, claims 1-10, characterized by the Examiner as drawn to a semiconductor resin mold; and

Group II, claims 11-19, characterized by the Examiner as drawn to a semiconductor resin molding method.


Applicants provisionally elect to prosecute Group II, including claims 11-19, without traverse.

If there are any fees due in connection with the filing of this response that are not attached, please charge the fees to our Deposit Account No. 06-0916. If an extension of time under 37 C.F.R. §1.136 is required and not requested by attachment, such an extension is requested and the fee should be charged to our Deposit Account.

Respectfully submitted,

FINNEGAN, HENDERSON, FARABOW,  
GARRETT & DUNNER, L.L.P.

Dated: October 21, 2003

By:  Reg 24,014  
 Richard V. Burgujian  
Reg. No. 31,744

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